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**July 2015** 

# FQT7N10L

# N-Channel QFET® MOSFET

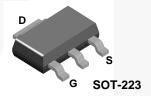
**100 V, 1.7 A, 350 m**Ω

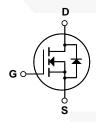
### **Description**

This N-Channel enhancement mode power MOSFET is produced using Fairchild Semiconductor's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, audio amplifier, DC motor control, and variable switching power applications.

### **Features**

- 1.7 A, 100 V,  $R_{DS(on)}$ =350 m $\Omega(Max.)$  @ $V_{GS}$ =10 V,  $I_D$ =0.85 A
- Low Gate Charge (Typ. 5.8 nC)
- Low Crss (Typ. 10 pF)
- 100% Avalanche Tested





## Absolute Maximum Ratings T<sub>A</sub> = 25°C unless otherwise noted

Symbol	Parameter		FQT7N10L	Unit	
V <sub>DSS</sub>	Drain-Source Voltage		100	V	
I <sub>D</sub>	Drain Current - Continuous (T <sub>A</sub> = 25°C) - Continuous (T <sub>A</sub> = 70°C)		1.7	A	
			1.36	Α	
I <sub>DM</sub>	Drain Current - Pulsed	(Note 1)	6.8	Α	
V <sub>GSS</sub>	Gate-Source Voltage		± 20	V	
E <sub>AS</sub>	Single Pulsed Avalanche Energy	(Note 2)	50	mJ	
I <sub>AR</sub>	Avalanche Current	(Note 1)	1.7	Α	
E <sub>AR</sub>	Repetitive Avalanche Energy	(Note 1)	0.2	mJ	
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	6.0	V/ns	
$P_{D}$	Power Dissipation (T <sub>A</sub> = 25°C)		2.0	W	
	- Derate above 25°C		0.016	W/°C	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range		-55 to +150	°C	
TL	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds		300	°C	
'L			300		

### **Thermal Characteristics**

Symbol	Parameter	Тур	Max	Unit
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient *		62.5	°C/W

<sup>\*</sup> When mounted on the minimum pad size recommended (PCB Mount)

Symbol	Parameter	Test Conditions		Тур	Max	Unit
Off Cha	aracteristics					
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$				V
ΔBV <sub>DSS</sub> / ΔT <sub>J</sub>	Breakdown Voltage Temperature Coefficient	I <sub>D</sub> = 250 μA, Referenced to 25°C		0.1		V/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 100 V, V <sub>GS</sub> = 0 V			1	μΑ
		V <sub>DS</sub> = 80 V, T <sub>C</sub> = 125°C			10	μΑ
I <sub>GSSF</sub>	Gate-Body Leakage Current, Forward	V <sub>GS</sub> = 20 V, V <sub>DS</sub> = 0 V			100	nA
I <sub>GSSR</sub>	Gate-Body Leakage Current, Reverse	$V_{GS} = -20 \text{ V}, V_{DS} = 0 \text{ V}$			-100	nA
On Cha	aracteristics		·			
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu\text{A}$	1.0		2.0	V
R <sub>DS(on)</sub>	Static Drain-Source	$V_{GS} = 10 \text{ V}, I_D = 0.85 \text{ A}$		0.275	0.35	
	On-Resistance	$V_{GS} = 5 \text{ V}, I_D = 0.85 \text{ A}$		0.300	0.38	Ω
9 <sub>FS</sub>	Forward Transconductance	V <sub>DS</sub> = 30 V, I <sub>D</sub> = 0.85 A (Note	4)	2.75		S
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> = 25 V, V <sub>GS</sub> = 0 V,		220	290	pF
Coss	Output Capacitance	f = 1.0 MHz		55	72	pF
C <sub>rss</sub>	Reverse Transfer Capacitance			12	15	pF
Switchi	ing Characteristics					
t <sub>d(on)</sub>	Turn-On Delay Time	V 50VI 70A		9	30	ns
t <sub>r</sub>	Turn-On Rise Time	$V_{DD} = 50 \text{ V}, I_D = 7.3 \text{ A},$		100	210	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	$R_G = 25 \Omega$		17	45	ns
t <sub>f</sub>	Turn-Off Fall Time	(Note 4	, 5)	50	110	ns
Q <sub>q</sub>	Total Gate Charge	$V_{DS} = 80 \text{ V}, I_{D} = 7.3 \text{ A},$		4.6	6.0	nC
Q <sub>gs</sub>	Gate-Source Charge	$V_{GS} = 5 \text{ V}$		1.0		nC
Q <sub>gd</sub>	Gate-Drain Charge	(Note 4	, 5)	2.6		nC
Drain-S	Source Diode Characteristics a	nd Maximum Ratings				1
I <sub>S</sub>	Maximum Continuous Drain-Source Diode Forward Current				1.7	Α
	Maximum Pulsed Drain-Source Diode F	num Pulsed Drain-Source Diode Forward Current			6.8	Α
I <sub>SM</sub>		\/ 0\/ L 47A			1.5	V
	Drain-Source Diode Forward Voltage	$V_{GS} = 0 \text{ V}, I_{S} = 1.7 \text{ A}$			1.5	· ·
$V_{SD}$	Drain-Source Diode Forward Voltage Reverse Recovery Time	$V_{GS} = 0 \text{ V, } I_S = 1.7 \text{ A}$ $V_{GS} = 0 \text{ V, } I_S = 7.3 \text{ A,}$		70		ns

- **Notes:** 1. Repetitive Rating : Pulse width limited by maximum junction temperature 2. L = 26mH, I $_{AS}$  = 1.7A, V $_{DD}$  = 25V, R $_{G}$  = 25  $\Omega$ , Starting T $_{J}$  = 25°C 3. I $_{SD}$   $\leq$  7.3A, di/dt  $\leq$  300A/ $_{HS}$ , V $_{DD}$   $\leq$  BV $_{DSS}$ , Starting T $_{J}$  = 25°C 4. Pulse Test : Pulse width  $\leq$  300 $_{HS}$ , Duty cycle  $\leq$  2% 5. Essentially independent of operating temperature

# **Typical Characteristics**

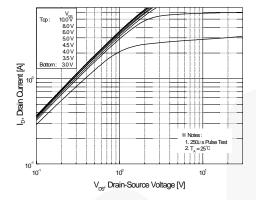


Figure 1. On-Region Characteristics

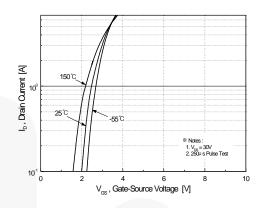


Figure 2. Transfer Characteristics

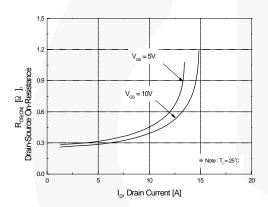


Figure 3. On-Resistance Variation vs.
Drain Current and Gate Voltage

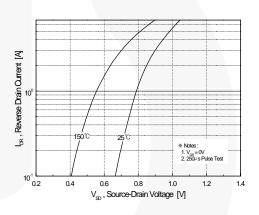


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

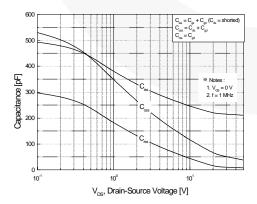


Figure 5. Capacitance Characteristics

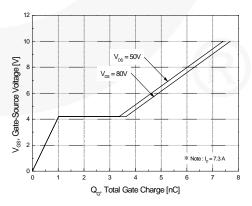
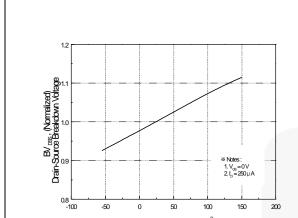


Figure 6. Gate Charge Characteristics



-50

Typical Characteristics (Continued)



T,, Junction Temperature [°C]

150

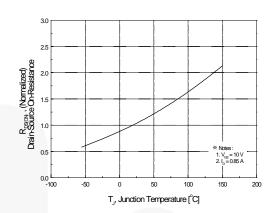


Figure 8. On-Resistance Variation vs. Temperature

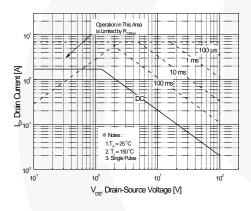


Figure 9. Maximum Safe Operating Area

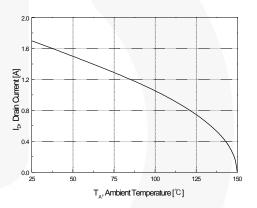


Figure 10. Maximum Drain Current vs. Ambient Temperature

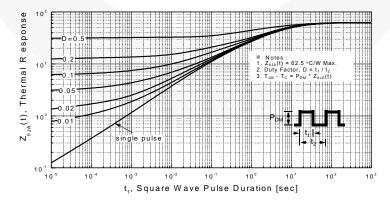
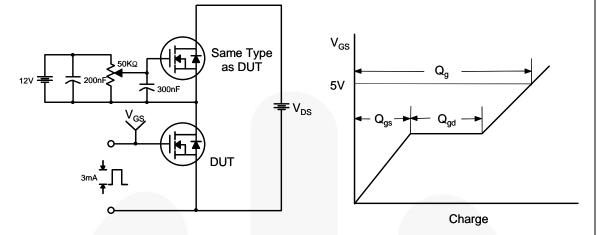
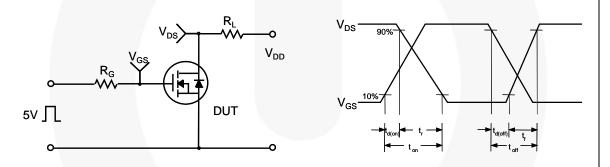


Figure 11. Transient Thermal Response Curve

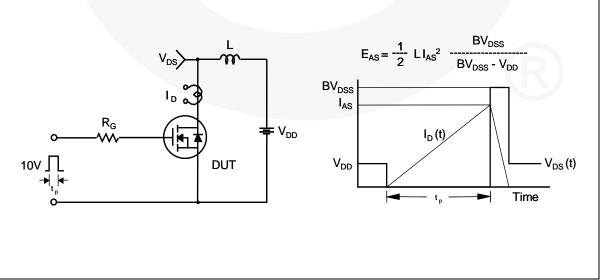
## **Gate Charge Test Circuit & Waveform**

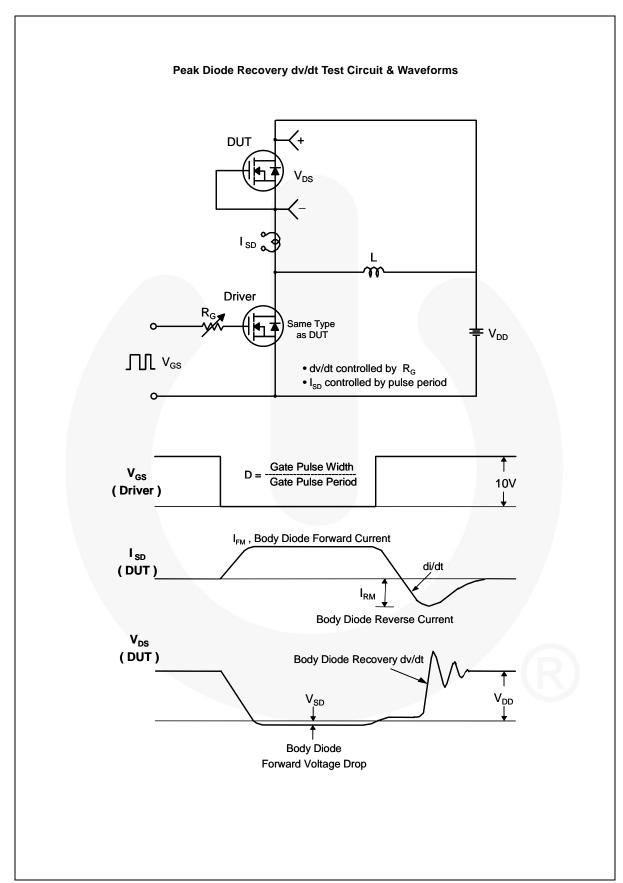


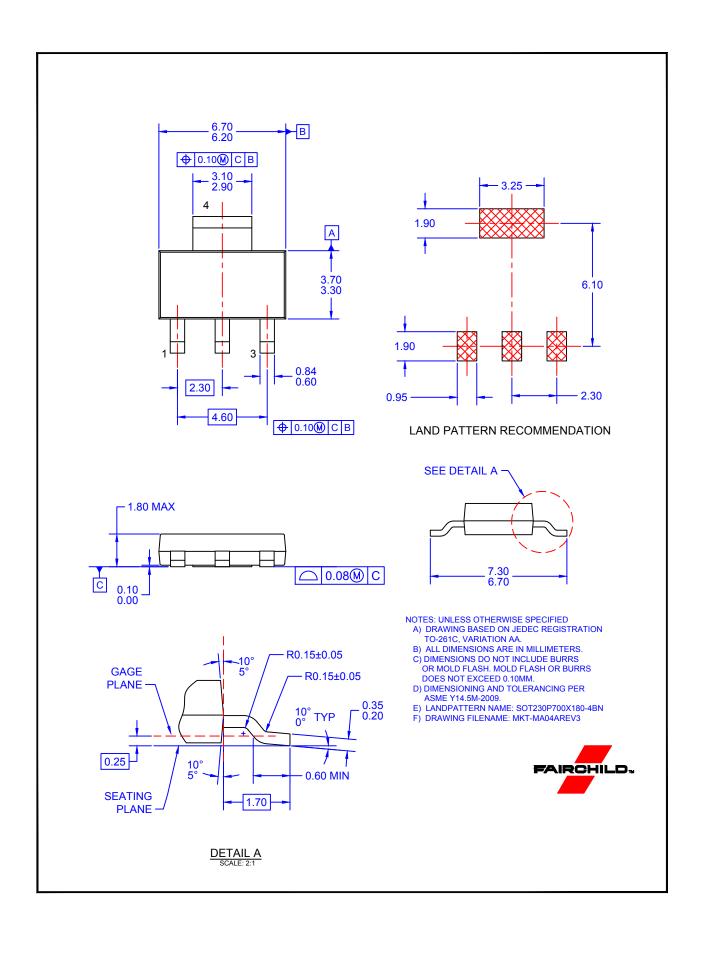
### **Resistive Switching Test Circuit & Waveforms**



### **Unclamped Inductive Switching Test Circuit & Waveforms**







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